

# HiPerFET™ Power MOSFETs Q-Class

IXFH 80N15Q IXFK 80N15Q IXFT 80N15Q

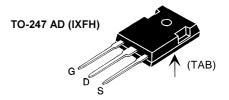
 $V_{DSS} = 150 V$   $I_{D25} = 80 A$   $R_{DS(on)} = 22.5 m\Omega$   $t \le 200 ns$ 

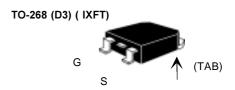
N-Channel Enhancement Mode Avalanche Rated, High dv/dt, Low  $Q_{q}$ 

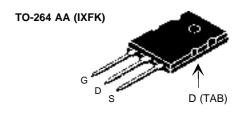


Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>1</sub> = 25°C to 150°C		150	V
V <sub>DGR</sub>	$T_J^\circ = 25^\circ C$ to 150°C; $R_{GS} = 1 \text{ M}\Omega$		150	V
V <sub>GS</sub>	Continuous		±20	V
V <sub>GSM</sub>	Transient		±30	V
I <sub>D25</sub>	T <sub>c</sub> = 25°C		80	Α
I <sub>DM</sub>	$T_{c} = 25^{\circ}$ C, pulse width limited b	y T <sub>.im</sub>	320	Α
I <sub>AR</sub>	$T_{c} = 25^{\circ}C$	····	80	Α
E <sub>AR</sub>	T <sub>C</sub> = 25°C		45	mJ
E <sub>AS</sub>	$T_{c}^{\circ} = 25^{\circ}C$		1.5	J
dv/dt	$I_{_{S}} \leq I_{_{DM}}$ , di/dt $\leq$ 100 A/ $\mu$ s, $V_{_{DD}} \leq V$ $T_{_{J}} \leq 150^{\circ}$ C, $R_{_{G}} = 2~\Omega$	DSS'	5	V/ns
$\overline{\mathbf{P}_{\scriptscriptstyle \mathrm{D}}}$	$T_{c} = 25^{\circ}C$		360	W
			-55 +150	°C
Τ,,,			150	°C
T <sub>stg</sub>			-55 +150	°C
T <sub>L</sub>	1.6 mm (0.063 in) from case for	10 s	300	°C
M <sub>d</sub>	Mounting torque	TO-247	1.13/10 N	m/lb.in.
		TO-264	0.9/6 N	m/lb.in.

M <sub>d</sub>	Mounting torque	TO-247		1.13/	'10 Nm/	lb.in.
		TO-264	•	0.9	9/6 Nm/	lb.in.
Weight		TO-247			6	g
		TO-264			10	g
		TO-268			4	<u>g</u>
Symbol	<b>Test Conditions</b>	(T <sub>J</sub> = 25°C, u			ristic Va se spec   max.	
$\overline{\mathbf{V}_{\mathrm{DSS}}}$	$V_{GS} = 0 \text{ V}, I_{D} = 250 \text{ uA}$		150			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 4 \text{ mA}$		2.0		4.0	V
I <sub>GSS</sub>	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$				±100	nΑ
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	$T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$			25 1	μA mA
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 0.5 \bullet I_{D25}$ Pulse test, t \le 300 \mus, du	ty cycle d ≤ 2 %			22.5	mΩ







G = Gate S = Source TAB = Drain

# **Features**

- Low gate charge
- International standard packages
- Epoxy meet UL 94 V-0, flammability classification
- $^{ullet}$  Low R<sub>DS (on)</sub> HDMOS<sup>TM</sup> process
- Rugged polysilicon gate cell structure
- Avalanche energy and current rated
- Fast intrinsic Rectifier

### **Advantages**

- Easy to mount
- Space savings
- High power density



# IXFH 80N15Q IXFK 80N15Q IXFT 80N15Q

Symbol	Test Conditions Cha $(T_J = 25^{\circ}C, \text{ unless } C \text{ min.})$		
g <sub>fs</sub>	$V_{DS} = 10 \text{ V}; I_{D} = 0.5 \cdot I_{D25}, \text{ pulse test}$ 35	50	S
C <sub>iss</sub>	)	4500	pF
C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	1400	pF
$\mathbf{C}_{rss}$	J	680	pF
t <sub>d(on)</sub>	)	30	ns
t <sub>r</sub>	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$	55	ns
$\mathbf{t}_{d(off)}$	$R_{\rm G} = 2.0 \Omega$ (External),	68	ns
t <sub>f</sub>	)	20	ns
Q <sub>g(on)</sub>	)	180	nC
$\mathbf{Q}_{gs}$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$	39	nC
$\mathbf{Q}_{gd}$	)	85	nC
R <sub>thJC</sub>			0.35 K/W
R <sub>thCK</sub>	TO-247 TO-264	0.25 0.15	K/W K/W

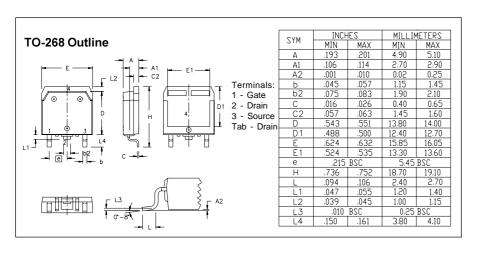
TO-247 AD (IXFH) Outline						
Terminals:  1 - Gate 2 - Drain 3 - Source Tab - Drain						
	Dim.	Milli Min.	meter Max.	Inch Min.	nes Max.	
	A A <sub>1</sub> A <sub>2</sub>	4.7 2.2 2.2	5.3 2.54 2.6	.185 .087 .059	.209 .102 .098	
	b b <sub>1</sub> b <sub>2</sub>	1.0 1.65 2.87	1.4 2.13 3.12	.040 .065 .113	.055 .084 .123	
	C D E	.4 20.80 15.75	.8 21.46 16.26	.016 .819 .610	.031 .845 .640	
	e L L1	5.20 19.81	5.72 20.32 4.50	0.205 .780	0.225 .800 .177	
	ØP Q	3.55 5.89	3.65 6.40	.140 0.232	.144 0.252	
	R S	4.32 6.15	5.49 BSC	.170 242	.216 BSC	

## Source-Drain Diode

# **Characteristic Values**

(T<sub>J</sub> = 25°C, unless otherwise specified) min. | tvp. | max.

Symbol	Test Conditions	min.	typ.	max.	
I <sub>s</sub>	V <sub>GS</sub> = 0 V			80	Α
I <sub>sm</sub>	Repetitive; pulse width limited by ${\rm T_{\scriptscriptstyle JM}}$			320	Α
$\mathbf{V}_{\mathtt{sd}}$	$I_F = I_S$ , $V_{GS} = 0$ V, Pulse test, t $\leq$ 300 $\mu$ s, duty cycle d $\leq$ 2 %			1.5	V
t <sub>rr</sub> Q <sub>RM</sub> I <sub>RM</sub>			1.2 10	200	ns μC Α



# TO-264 AA Outline

Dim.	Millin	neter	Inches		
J	Min.	Max.	Min.	Max.	
Α	4.82	5.13	.190	.202	
A1	2.54	2.89	.100	.114	
A2	2.00	2.10	.079	.083	
b	1.12	1.42	.044	.056	
b1	2.39	2.69	.094	.106	
b2	2.90	3.09	.114	.122	
С	0.53	0.83	.021	.033	
D	25.91	26.16	1.020	1.030	
Е	19.81	19.96	.780	.786	
е	5.46	BSC	.215BSC		
J	0.00	0.25	.000	.010	
K	0.00	0.25	.000	.010	
L	20.32	20.83	.800	.820	
L1	2.29	2.59	.090	.102	
Р	3.17	3.66	.125	.144	
Q	6.07	6.27	.239	.247	
Q1	8.38	8.69	.330	.342	
R	3.81	4.32	.150	.170	
R1	1.78	2.29	.070	.090	
S	6.04	6.30	.238	.248	
Т	1.57	1.83	.062	.072	

IXYS reserves the right to change limits, test conditions, and dimensions.